

600V Super-junction Power MOSFET

Description

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Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The Multi-EPI SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

Features

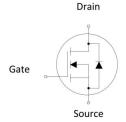
- Very low FOM $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- Easy to use/drive
- RoHS compliant

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Charger

TO-220FP-NL







Device Marking and Package Information

Device	Package	Marking	
TPR60R110M	TO-220FP-NL	60R110M	

Key Performance Parameters

Parameter	Value	Unit
V _{DS} @ T _{j,max}	650	V
R _{DS(on),max}	0.11	Ω
$Q_{g,typ}$	54.5	nC
I _D	30	A
I _{D,pulse}	90	A
E _{OSS} @ 400V	7.67	μЈ
Body Diode di _F /dt	500	A/μs



Absolute Maximum Ratings T _C = 25°C, unless otherwise noted						
Parameter			Symbol	Values	Unit	
Continuous Drain Current	T _C = 25°C			30		
	T _C = 100°C		l _D	18	A	
Pulsed Drain Current	•	(note1)	I _{D,pulse}	90	А	
Gate-Source Voltage			V_{GSS}	±30V	V	
Single Pulse Avalanche Energy		(note2)	E _{AS}	636	mJ	
Repetitive Avalanche Energy		(note2)	E _{AR}	0.96	mJ	
Avalanche Current			I _{AR}	5.2	Α	
MOSFET dv/dt Ruggedness, V _{DS} = 0480V		dv/dt	50	V/ns		
Power Dissipation For TO-220FP-NL		P_{D}	34	W		
Continuous Diode Forward Current			I _S	25.5	A	
Diode Pulsed Current (note		(note1)	I _{S,pulse}	90		
Reverse Diode dv/dt (note3)		(note3)	dv/dt	15	V/ns	
Maximum Diode Commutation Speed (note3)		(note3)	di _f /dt	500	A/µs	
Operating Junction and Storage Temperature Range		T_J,T_stg	-55~+150	°C		

Thermal Resistance For TO-220FP-NL				
Parameter	Symbol	Value	Unit	
Thermal Resistance, Junction-to-Case	R _{thJC}	3.65	°C/W	
Thermal Resistance, Junction-to-Ambient	R _{thJA}	80	-0/00	

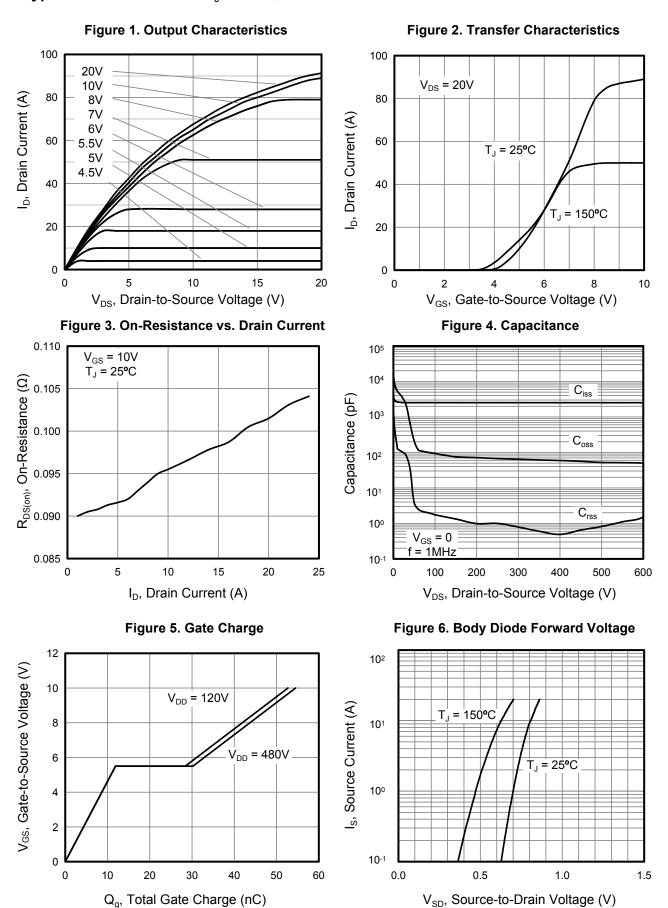


D			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	600			V	
Zoro Coto Voltago Drain Current		$V_{DS} = 600V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V, T _J = 150°C			100		
Gate-Source Leakage Current	I _{GSS}	V _{GS} = ±30V			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V	
Drain-Source On-State-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 15A		0.096	0.11	Ω	
Gate Resistance	R_G	f = 1.0MHz open drain		1.74		Ω	
Dynamic Characteristics	•						
Input Capacitance	C _{iss}	\/ - 0\/		2531		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 100V$		92.8			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		1.75			
Total Gate Charge	Qg	\/ = 490\/		54.5			
Gate-Source Charge	Q_{gs}	$V_{DD} = 480V$, $I_{D} = 30A$,		11.9		nC	
Gate-Drain Charge	Q_{gd}	V _{GS} = 10V		18.3			
Turn-on Delay Time	t _{d(on)}			56.5			
Turn-on Rise Time	t _r	V _{DD} = 400V		47.4			
Turn-off Delay Time	t _{d(off)}	$I_D = 30A$ $R_G = 25\Omega$		206		ns	
Turn-off Fall Time	t _f			65.8			
Drain-Source Body Diode Characteristics							
Body Diode Forward Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 15\text{A}, V_{GS} = 0\text{V}$		0.9	1.2	V	
Reverse Recovery Time	t _{rr}			260		ns	
Reverse Recovery Charge	Q _{rr}	$V_R = 25V$, $I_F = 4.61A$, $di_F/dt = 100A/\mu s$		2.4		μC	
Peak Reverse Recovery Current	I _{rrm}	,		18.7		Α	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. $I_D = 10A$, $V_{DD} = 50V$, $R_G = 25Ω$, Starting $T_J = 25$ °C
- 3. Identical low side and high side switch with identical ${\rm R}_{\rm G}$

Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted



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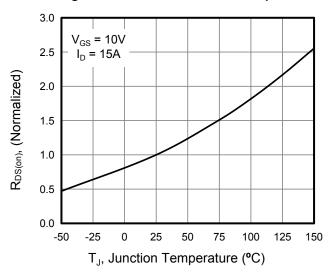


Figure 8. Breakdown Voltage vs. Junction Temperature

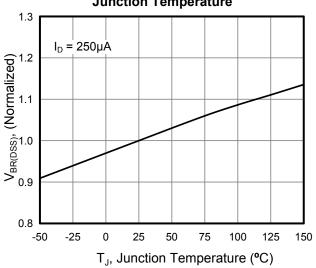


Figure 9. Transient Thermal Impedance For TO-220FP-NL

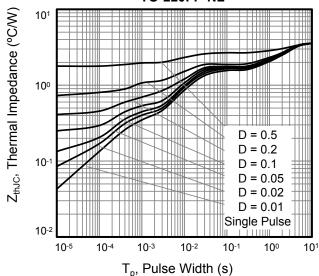


Figure 10. Safe Operation Area For TO-220FP-NL

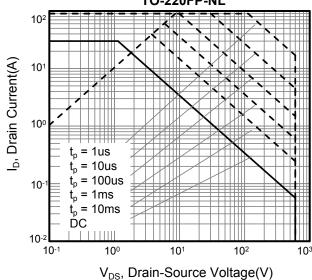
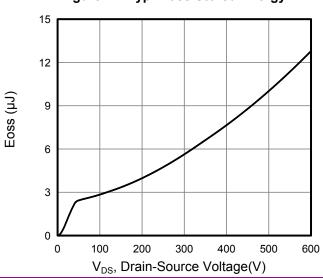


Figure 11. Typ. Coss Stored Energy



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Figure A: Gate Charge Test Circuit and Waveform

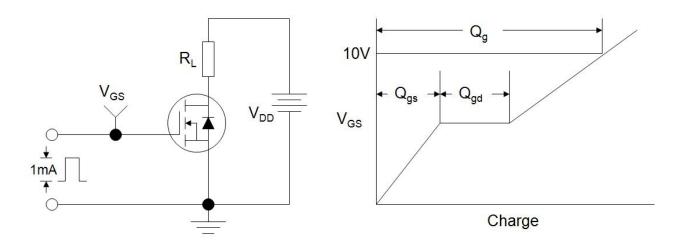


Figure B: Resistive Switching Test Circuit and Waveform

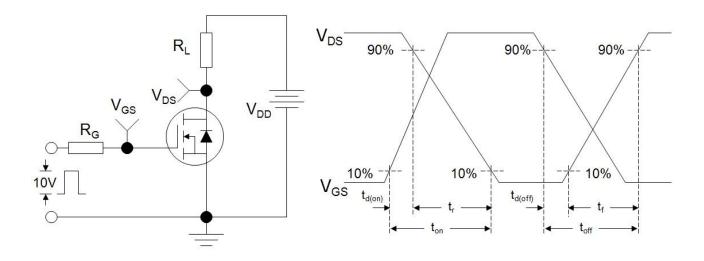
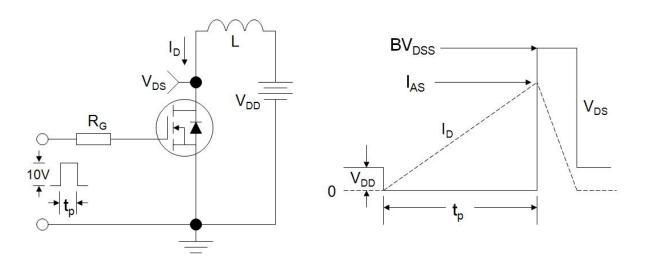
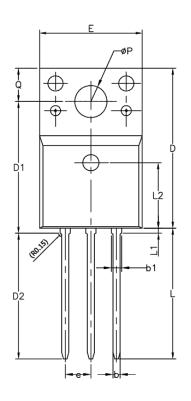


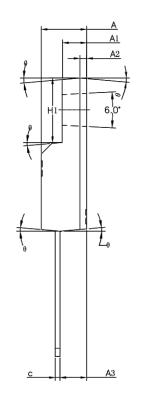
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

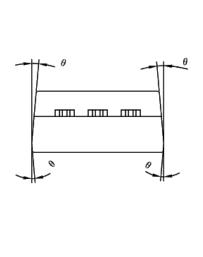




TO-220FP-NL







SYMBOL	MIN	NOM	MAX	
Α	4.50	4.70	4.83	
A1	2.34	2.54	2.74	
A2		0.70 RI	EF.	
A3	2.56	2.76	2.93	
b	0.60	_	0.80	
b1	0.90	_	1.10	
С	0.45	0.50	0.60	
D	15.67	15.87	16.07	
D1	12.87	13.07	13.27	
D2	12.28	12.48	12.68	
Е	9.96	10.16	10.36	
е	2.54BSC			
H1	6.48	6.68	6.88	
L	12.68	12.98	13.28	
L1	_	_	0.85	
L2	6.50REF			
øΡ	3.08	3.18	3.28	
Q	3.20	_	3.40	
θ 1	1°	3°	5°	



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